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NO: DSFN0497E001A

# SPECIFICATION OF MODULE

# MODULE NO: ZC-049701-0101 RoHS Complaint Product

Customer Approval:	
☐ Accept	□ Reject

ZOYO FOCUS	SIGNATURE	DATE
PREPARED BY	JYQ	2024.09.12
CHECKED BY	YG	2024.09.12
APPROVED BY		

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Hangzhou ZoYo Chuxian Intelligent Techonology Co.,Ltd.

Add: 6F, No.96, Fangxingdu Street, Linping District, Hangzhou, Zhejiang, China



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Sample Version	Doc. Version	DATE	DESCRIPTION	CHECKED BY
01	A	2024.09.12	First Release.	YG



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# **1. GENERAL DESCRIPTION:**

 $\underline{ZC} - \underline{0497} \quad \underline{01} - \underline{0101}$ 

1

2

(3)

**(4)** 

(1) ZOYO Focus Brand

2 Display size: 4.97inch

3 LCM serial NO.

4 serial NO.

### **2. MECHANICAL SPECIFICATIONS:**

ITEM	SPECIFICATION	Remark
Module Outline Dimension(W x H x D)(mm)	64.12(W)×116.72(H)×0.84(D)	
Active Area(mm)	61.884(H)×110.016(V)	
Pixel Pitch (um)	28.65(H)X85.95(V)	
Resolution(dot)	720(H)×1280(V)	-
Driver IC(Type)	RM67295	-
Display Mode	AMOLED	-
Interface	MIPI	
Color Depth	16.7M	-
Luminance	350 (TYP.)	cd/m²
Viewing Direction	ALL	-

<sup>\*</sup>See attached drawing for details.

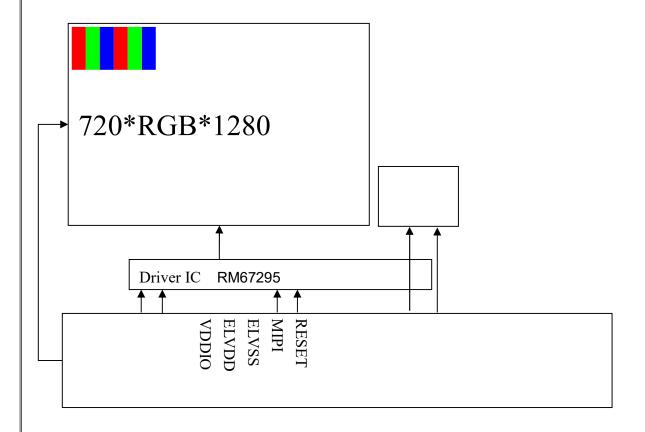


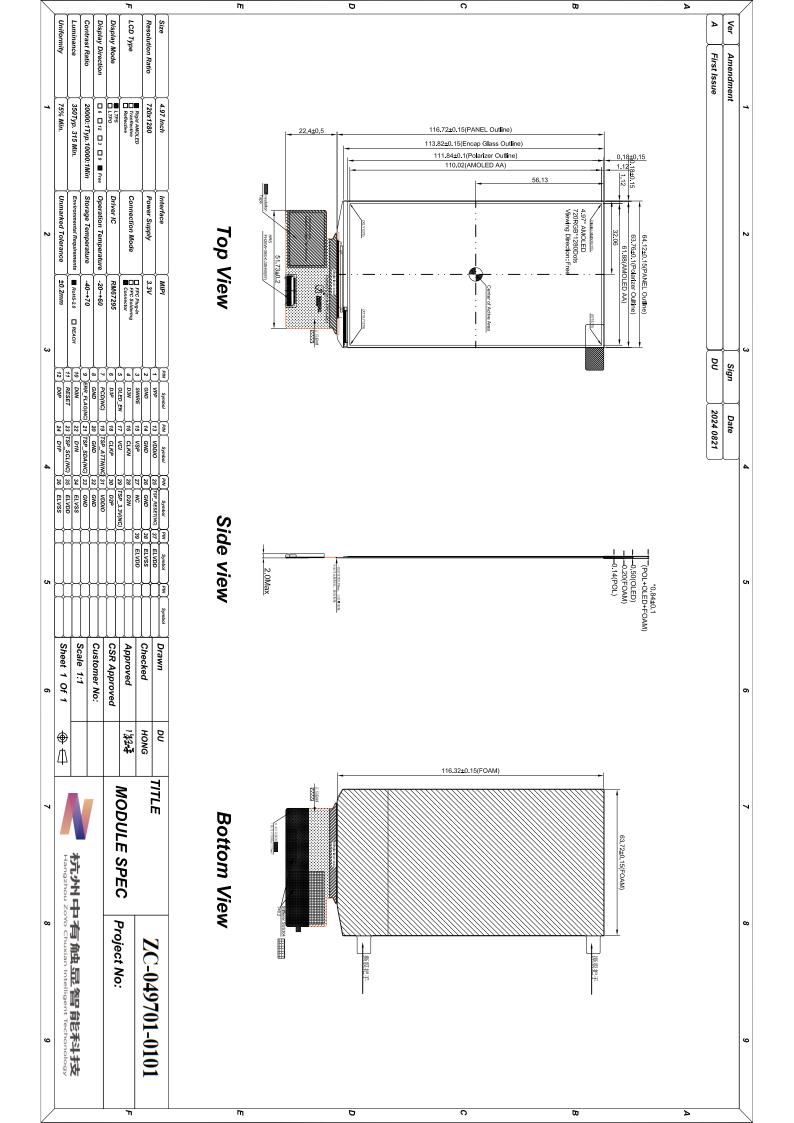
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# **3.BLOCK DIAGRAM:**







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# 5. MAIN FPC PIN DESCRIPTION:

Pin No.	Symbol	1/0	Description	Note.
1	VPP	Р	MTP OLED.	
2	GND	P	Ground.	
3	SWIRE	0	Power IC control pin.	
4	D3N	L	MIPI DSI Negative differential data signal.	ō.
5	OLED_EN	0	Power IC enable control pin (Note: "H" = VDDI level, "L" = VSSI level.)	0
6	D3P	1	MIPI DSI Positive differential data signal.	143
7	PCD(NC)	78	No connection.	
8	GND	Р	Ground.	
9	ERR_FLAG(NC)	2	No connection.	
10	DON	1	MIPI DSI Negative differential data signal.	9
11	RESET	1	Reset signal input.	
12	D0P	1	MIPI DSI Positive differential data signal.	
13	VDDIO	Р	Driver IC regulator power supply	
14	GND	P	Ground.	
15	VSP	Р	Input anode voltage from the set-up circuit.	
16	CLKN	I	MIPI DSI Negative clock signal.	
17	VCI	Р	Supply analog voltage.	
18	CLKP	1	MIPI DSI Positive clock signal.	
19	TSP_ATTN(NC)	7	No connection.	
20	GND	Р	Ground.	
21	TSP_SDA(NC)	-	No connection.	. 💝
22	DAN		MIDLECIAL CLUME COLLEGE	_

22	D1N	1	MIPI DSI Negative differential data signal.
23	TSP_SCL(NC)	-	No connection.
24	D1P	1	MIPI DSI Positive differential data signal.
25	TSP_RESET(NC)	828	No connection.
26	GND	Р	Ground.
27	NC		No connection.
28	D2N	1	MIPI DSI Negative differential data signal.
29	TSP_3.3V(NC)	8288	No connection.
30	D2P	1	MIPI DSI Positive differential data signal.
31	VDDIO	P	Driver IC regulator power supply.
32	GND	Р	Ground.
33	GND	Р	Ground.
34	ELVSS	Р	Negative Power supply for Panel.
35	ELVDD	Р	Positive Power supply for Panel.
36	ELVSS	Р	Negative Power supply for Panel.
37	ELVDD	Р	Positive Power supply for Panel.
38	ELVSS	Р	Negative Power supply for Panel.
39	ELVDD	Р	Positive Power supply for Panel.

Connector Name/Designation	Interface Connector/Interface Card
Type Part Number	HRS FH26W-39S-0.3SHW(97)
Mating Housing Part Number	FPC 39PIN 0.3Pitch

Note: I=Input; O=Output; P=Power; I/O=Input / Output



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# 6. <u>ELECTRICAL CHARACTERISTICS</u>

### **6.1 Absolute Maximum Ratings**

Parameter	Symbol	Min.	Max.	Unit	Remarks
Analog/boost power voltage	VCI	-0.3	5.5	V	
VCI I/O voltage	VCI_IF	-0.3	5.5	٧	
I/O voltage	VDDI	-0.3	5.5	V	
VSP voltage	VSP	-0.3	6.6	٧	
VPP(OTP power)	VPP	- 2	8.25	٧	
Operating temperature	Тор	-20	60	°C	
Storage temperature	Tstg	-40	70	°C	

### **6.2 Electrical Characteristics**

Parameter	Symbol	Condition	Min.	Тур.	Max.	Uni
AMOLED Power positive	ELVDD	122		4.6		٧
AMOLED power Negative	ELVSS	722	-22	-2.5	122	V
Gamma Voltage	VSP	X <del>-1</del>	55	6.4	s	V
Digital Power supply	VDDI	N <del></del>	1.65	1.8	3.3	٧
Analog Power supply	VCI		2.5	3.3	3.6	٧
	IELVDD/ELVSS	VELVDD=4.6V	727	160	190	mA
350 nits @Gray 255	IVCI	VELVSS=-2.5V VCI=3.3V		1.5	2	mA
	IVDDIO	VDDIO=1.8V	125.5	15	20	mA





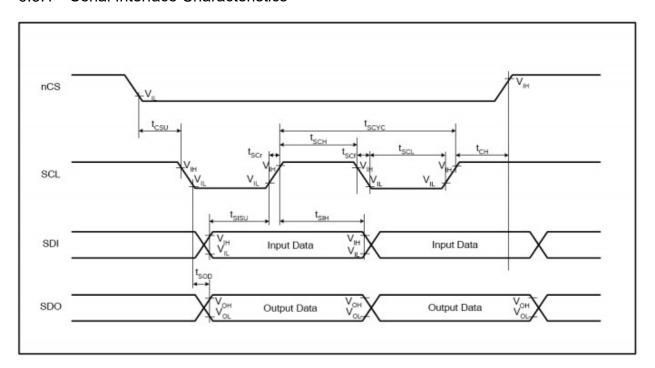
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#### **6.3 AC Characteristics**

#### 6.3.1 Serial Interface Characteristics



Signal	Symbol	Parameter	MIN	MAX	Unit	Description
	T <sub>SCYC</sub>	Clock cycle (Write)	100		ns	
	T <sub>SCYC</sub>	Clock cycle (Read)	300		ns	
	T <sub>SCH</sub>	Clock "H" pulse width (Write)	40	8	ns	
SCL	T <sub>SCH</sub>	Clock "H" pulse width (Read)	140	1	ns	
SCL	T <sub>SCL</sub>	Clock "L" pulse width (Write)	40	8 5	ns	-
	T <sub>SCL</sub>	Clock "L" pulse width (Read)	140		ns	
	Tscr	Clock rise time		5	ns	
	Tscf	Clock fall time		5	ns	
nCS	T <sub>CSU</sub>	Chip select setup time	20	100	ns	
nos	T <sub>CH</sub>	Chip select hold time	50	1 5	ns	-
SDI	T <sub>SISU</sub>	Data input setup time	20	8.5	ns	
SDI	T <sub>SIH</sub>	Data input hold time	20	The second	ns	
SDO	T <sub>SOD</sub>	Data output setup time		120	ns	
300	T <sub>SOH</sub>	Data output hold time	5		ns	1

Note: Logic high and low levels are specified as 20% and 80% of IOVCC for Input signals.

Note: Ta = -30 to 70 °C, IOVCC=1.65V to 3.3V, VDD=2.5V to 3.6V, GND=0V





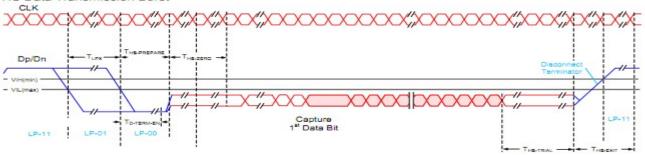
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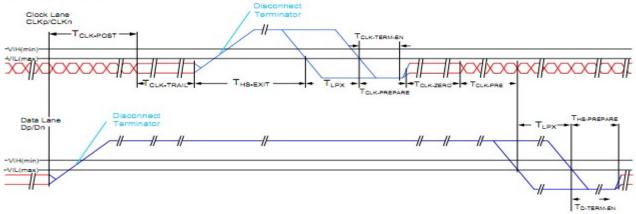
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#### 6.3.2 DSI Timing Characteristics









Timing Parameters:

Timing Param Parameter	Description	Min	Тур	Max	Unit
T <sub>CLK-POST</sub>	Time that the transmitter continues to send HS clock after the last associated Data Lane has transitioned to LP Mode. Interval is defined as the period from the end of Ths-trail to the beginning of Tclk-trail.	60ns + 52*UI			ns
CLK-TRAIL	Time that the transmitter drives the HS-0 state after the last payload clock bit of a HS transmission burst.	60			ns
T <sub>HS-EXIT</sub>	Time that the transmitter drives LP-11 following a HS burst.	300			ns
T <sub>CLK-TERM-EN</sub>	Time for the Clock Lane receiver to enable the HS line termination, starting from the time point when Dn crosses V <sub>IL,MAX</sub> .	Time for Dn to reach V <sub>TERM-EN</sub>		38	ns
T <sub>CLK-PREPARE</sub>	Time that the transmitter drives the Clock Lane LP-00 Line state immediately before the HS-0 Line state starting the HS transmission.	38		95	ns
C <sub>CLK-PRE</sub>	Time that the HS clock shall be driven by the transmitter prior to any associated Data Lane beginning the transition from LP to HS mode.	8			UI
T <sub>CLK-PREPARE</sub> + T <sub>CLK-ZERO</sub>	T <sub>CLK-PREPARE</sub> + time that the transmitter drives the HS-0 state prior to starting the Clock.	300			ns
T <sub>D-TERM-EN</sub>	Time for the Data Lane receiver to enable the HS line termination, starting from the time point when Dn crosses V <sub>ILMAX</sub> .	Time for Dn to reach V <sub>TERM-EN</sub>		35 ns +4*UI	
T <sub>HS-PREPARE</sub>	Time that the transmitter drives the Data Lane LP-00 Line state immediately before the HS-0 Line state starting the HS transmission	40ns + 4*UI		85 ns + 6*UI	ns
T <sub>HS-PREPARE</sub> + T <sub>HS-ZERO</sub>	T <sub>HS-PREPARE</sub> + time that the transmitter drives the HS-0 state prior to transmitting the Sync sequence.	145ns + 10*UI			ns
T <sub>HS-TRAIL</sub>	Time that the transmitter drives the flipped differential state after last payload data bit of a HS transmission burst	60ns + 4*UI			ns

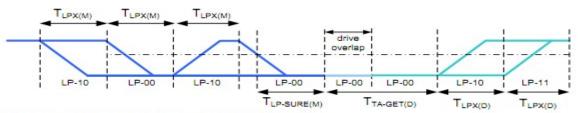




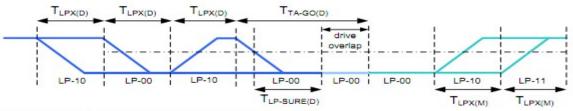
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Bus turnaround (BAT) from MPU to display module timing



Bus turnaround (BAT) from display module to MPU timing

#### Low Power Mode :

Parameter	Description	Min	Тур	Max	Unit	Notes
T <sub>LPX(M)</sub>	Transmitted length of any Low-Power state period of MCU to display module	50		150	ns	1,2
T <sub>TA-SURE(M)</sub>	Time that the display module waits after the LP-10 state before transmitting the Bridge state (LP-00) during a Link Turnaround.	T <sub>LPX(M)</sub>		2*T <sub>LPX(M)</sub>	ns	2
T <sub>LPX(D)</sub>	Transmitted length of any Low-Power state period of display module to MCU	50		150	ns	1,2
$T_{TA\text{-}GET(D)}$	Time that the display module drives the Bridge state (LP-00) after accepting control during a Link Turnaround.		5*T <sub>LPX(D)</sub>		ns	2
T <sub>TA-GO(D)</sub>	Time that the display module drives the Bridge state (LP-00) before releasing control during a Link Turnaround.		4*T <sub>LPX(D)</sub>		ns	2
T <sub>TA-SURE(D)</sub>	Time that the MPU waits after the LP-10 state before transmitting the Bridge state (LP-00) during a Link Turnaround.	T <sub>LPX(D)</sub>		2*T <sub>LPX(D)</sub>	ns	2

#### NOTE:

- T<sub>LPX</sub> is an internal state machine timing reference. Externally measured values may differ slightly from the specified values due to asymmetrical rise and fall times.
- 2. Transmitter-specific paramete



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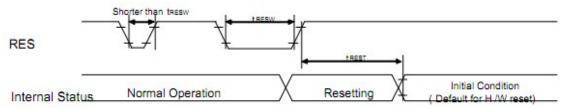
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#### 6.3.3 Display RESET Timing Characteristics



Reset input timing:

IOVCC=1.65 to 3.6V, VDD=2.5 to 3.6V, AGND=DGND=0V, Ta=-40 to 85℃

Symbol	Parameter	Related Pins	MIN	TYP	MAX	Note	Unit
t <sub>RESW</sub>	*1) Reset low pulse width	RESX	10	-	-	-	μS
t <sub>REST</sub>	to Decet consists time	-	-	-	5	When reset applied during Sleep in mode	ms
	*2) Reset complete time	-		-	120	When reset applied during Sleep out mode	ms

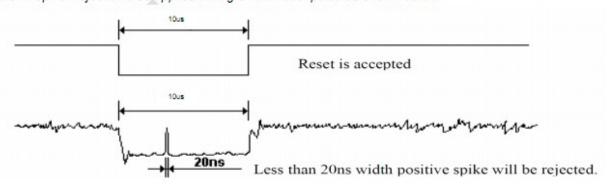
Note 1) Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the table below.

RESX Pulse	Action
Shorter than 5µs	Reset Rejected
Longer than 10μs	Reset
Between 5μs and 10μs	Reset starts (It depends on voltage and temperature condition.)

Note 2. During the resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep Out –mode. The display remains the blank state in Sleep In –mode) and then return to Default condition for H/W reset.

Note 3. During Reset Complete Time, data in OTP will be latched to internal register during this period. This loading is done every time when there is H/W reset complete time (tREST) within 5ms after a rising edge of RESX.

Note 4. Spike Rejection also applies during a valid reset pulse as shown below:



Note 5. It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120msec.



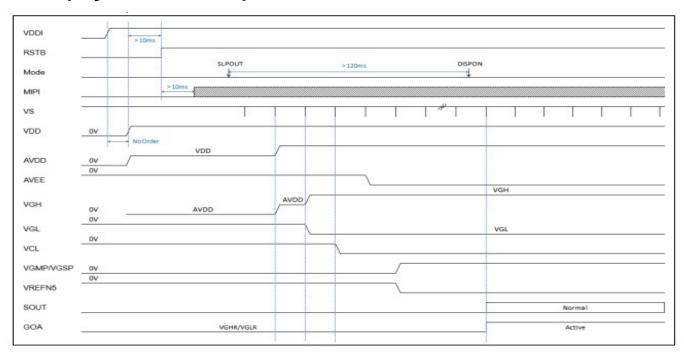
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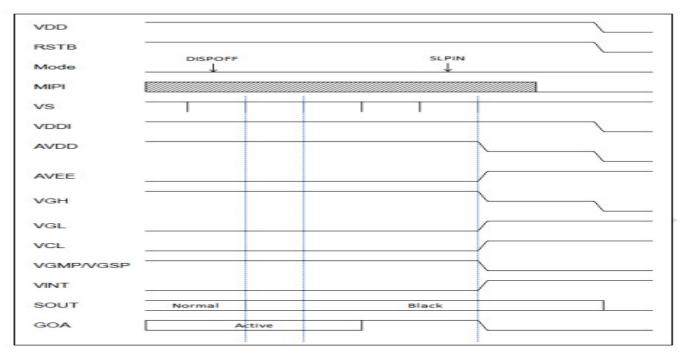
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### 7. RECOMMENDED OPERATING SEQUENCE

### 7.1 Display Power on Sequence



### 7.2 Display Power off Sequence





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### **8. OPTICAL CHARACTERISTICS**

The test of optical specifications shall be measured in a dark room (ambient luminance 1 lux and temperature = 25  $2^{\circ}$ C) with the equipment of the Luminance meter system (Goniometer system and TOPCON BM-5) and the test unit shall be located at an approximate distance 50cm from the LCD surface at a viewing angle of  $\theta$  and  $\Phi$  equal to 0 . We refer to  $\theta = 0 = 0 = 0$  (and  $\theta = 0$ ) as the 3 o'clock direction (the "right"),  $\theta = 0$  (and  $\theta = 0$ ) as the 12 o'clock direction ("upward"),  $\theta = 0$  (and  $\theta = 0$ ) as the 9 o'clock direction ("left") and  $\theta = 0$  (and  $\theta = 0$ ) as the 6 o'clock direction ("bottom"). While scanning  $\theta = 0$  and/or  $\theta = 0$ , the center of the measuring spot on the display surface shall stay fixed.

Item	Symbol	Condition	Min	Тур.	Max	Unit	Note
	θL		75	80	22	deg	Note 1
Marriage Apple	$\theta_R$	Cr≥10	75	80	122		
Viewing Angle	Ψτ	Cr≥10	75	80	122		
R	Ψв		75	80	122		
Contrast Ratio	Cr	θ=0°	10000	20000		02-0	Based on
Response Time	Tr+Tf	FF=0°			2	ms	Note 3
8	Wx		TBD	TBD	TBD	/- <del></del>	Note 4
	Wy		TBD	TBD	TBD		
	Rx		TBD	TBD	TBD		
Color Coordinate of	Ry		TBD	TBD	TBD		
CIE1931	Gx	θ=0°	TBD	TBD	TBD		
	Gy		TBD	TBD	TBD		
	Bx	1	TBD	TBD	TBD		
	Ву	1	TBD	TBD	TBD		
Uniformity	U		75	85		%	
Color Gamu	t		95	110		%	Note 5
OLED Lifetime		350nit T94	Т9	4>=120	)h		





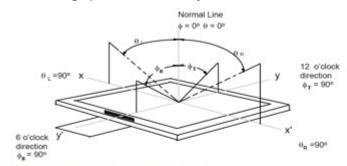
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### Note 1:The definition of Viewing Angle

Refer to the graph below marked by  $\theta$  and  $\phi$ .



#### Note2:ThedefinitionofContrastRatio

Contrast Ratio(CR)=

Luminance When LCD is at "White" state

Luminance When LCD is at "Black" state

(Contrast Ratio is measured in optimum common electrode voltage)

Note3:DefinitionofResponse time.(Test LCD using RD80S or similar equipments):

The output sign also photo detector are measured when the input sign also are changed from "black" to "white" (Voltage falling time) and from "white" to "black" (Voltage rising time), respectively. The response time is defined as the time interval between the 10% and 90% of amplitudes. Refer to figures below.

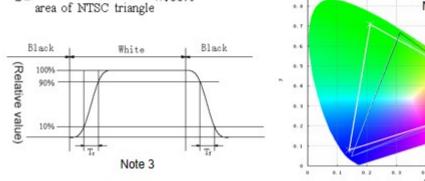
#### Note 4: Color Coordinates of CIE 1931

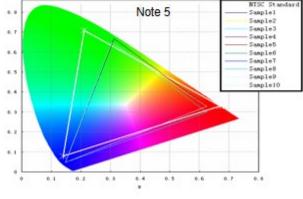
S = area of RGB triangle ×100%

The test condition is at ILED=20mA and measured on the surface of LCD module at 25°C. Measurement equipment:CS2000 or similar equipments

The Color Coordinate (CIE 1931) is the measurement of the center of the display shown in below figure.

#### Note 5: Definition of Color of CIE Coordinate and NTSC Ratio.







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# 10. PACKAGE

**TBD** 



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### 11. STANDARD SPECIFICATION FOR RELIABILITY:

No	Test Items	Conditions	Testing standard
1	High temperature storage Test	Ta=+70°C, 128 hours	IEC60068-2-1:2007 GB2423.2-2008
2	Low temperature storage Test	Ta=-40°C, 128 hours	IEC60068-2-1:2007 GB2423.1-2008
3	High temperature operation Test	Ta=+60°C, 128 hours	IEC60068-2-1:2007 GB2423.2-2008
4	Low temperature operation Test	Ta=-20°C, 128 hours	IEC60068-2-1:2007 GB2423.1-2008
5	High temperature & humidity (storage Test)	Ta=+60°C, 90%RH max, 128 hours	IEC60068-2-78:2001 GB/T2423.3-2006
6	Thermal shock Test	-40°C 30min~85°C 30min, Change time:1h/cycle,30cycle	Start with cold temperature End with high temperature IEC60068-2- 14:1984,GB2423.22-2002

### 12. QUALITY LEVEL

### 12.1 AMOLED Module of Characteristic Inspection

The environmental condition and visual inspection shall be conducted as below:

#### 12.1.1 Test conditions:

OLED is not light, cold white fluorescent lamp, illumination  $1000 \pm 200$ lux; OLED lighting source shall not be higher than 200lux, with black background around.

#### 12.1.2 Inspection distance:

the standard observation distance of all surfaces of the tested object is  $30\text{cm} \pm 5\text{cm}$ .

#### 12.1.3 Inspection angle:

the angle between the product and the horizontal plane is 45 °, and the eyes are perpendicular to the inspection plane. During inspection, the product needs to rotate 45 ° up, down, left and right. The observation line of sight needs to be within the half section of the cone. The observation angle is 45 ° with the vertical axis of the product apex. The central axis of the cone must be standard and perpendicular to the product surface and pass through the fluorescent lamp; For non-conventional display defects (including but not limited to local bright lines or local floodlights), the observation angle is 75 degrees from the normal of the product surface; Full visual angle of appearance.

#### 12.1.4 Inspection time:

the inspection time without lighting is at least 10-12 seconds; The time of OLED lighting inspection for each picture is 1~3 seconds. If the defect is still not visible within the specified time, the inspection piece is deemed to be qualified.



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12.1.5 Test temperature: room temperature 15-35 °C, ambient humidity: 20-75% RH.

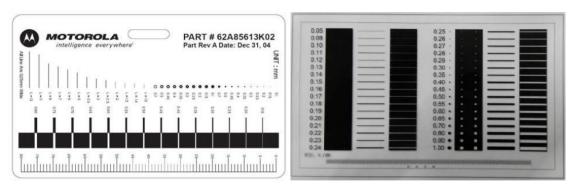
#### 12.1.6 Inspection tools:

#### 12.1.6.1 ND Filter:

The ND Filter is placed at a distance of 2-3 cm above the defect for 2-3s to judge whether the defect is visible. As Figure below: (ND Filter is used to test mura isochromatic and light unevenness)



12.1.6.2 Point gauge (point gauge in the figure below is recommended), determination method: as shown in the figure, the point gauge film can cover is pass, and the point gauge film can not cover is Fail. For example, a maximum of 0.2mm same-color spot defect is allowed on the Class A surface, and the pass that can be covered by 0.2mm on the film. The one that can be covered is Fail.







Imperfections of various shapes

Inspection Dot



Pass: Imperfection is smaller than the inspection dot



Fail: Imperfection is larger than the inspection dot

- 12.1.6.3 Microscopic examination: use 20-50 times adjustable microscope and 10-30 times test eyepiece.
- 12.1.6.4 Digital caliper: resolution 0.01mm.
- 12.1.6.5 Projector: anime microscope, 3D projector.
- 12.1.6.6 Judgment description:



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12.1.6.6.1 The measurement accuracy shall refer to the specification definition. When the measurement equipment accuracy is higher than the specification definition, the measured value needs to be rounded to the precision defined by the specification the. For example, the size of edge collapse is 0.20mm, and the thousandth is the reference position, which is rounded to 0.200mm~0.204mm is OK,>=0.205mm, it is judged as NG.

12.1.6.6.2 In addition to the tools used above, if additional inspection tools are needed to assist the judgment, they can only be carried out after the coordination of both parties.

#### 12.1.6.6.3 Bad code and definition

Cod	e and name	legend	explain
N	Number	-	Visually calculate the number; The statistics of the total number of defects does not include the completely "omitted" part. For the column defined as "omitted" and "omitted", it is not counted as the number of defects if it meets the requirements, otherwise it is calculated as an independent defect.
L	Length (mm)		Dot line distinguishing rule: L is the long side, W is the short side  A. When L > 3W, handle as per line, otherwise
w	Width (mm)		handle as per point; B. When it is judged as line defect, S-shaped or C-shaped line appears, and the enclosed amount is less than 3/4 circle, it shall be treated as line defect; otherwise, it shall be treated as point defect, and the inner tangent circle shall simulate the size of point.
S	Area (mm2)		Surface gauge
D	Diameter (mm) D=(L+W)/2		Point diameter calculation: calculated by half of the sum of the long side and the short side, that is,





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			D=(L+W)/2, where D represents the diameter of the
			point, L is the long side, and W is the short side;
Н	Depth (mm)	-	Digital micrometer
DS	Distance (mm)	DS DS	Distance between two points or between two lines
State	matic diagram screen area	AAK GA K FAK OA	AA area: display area; GA area: GIP circuit area; FA area: Frit area; OA area: outside FA area
Le	eader area		Screen GIP circuit area, screen data circuit area
PAD Bangding District			COG/FOG Bonding alignment mark and Bonding Pad on LTPS substrate
PAD Non-state area			Screen test pad, cutting area and lead-free area on LTPS substrate
СТс	rimping area		Pin end screen test pad



division

Foreign matter

highlights

# 杭州中有触显智能科技



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the A area shall be judged according to the

AA area is visible.

a foreign matter bright spot

specification of the strictest area, and the back defect shall be judged according to whether the

Due to the foreign matter in the polarizer, the

phenomenon that appears as a bright spot is called

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Highlights	等于1/2子會基础好 十十十二十二十二十二十二十二十二十二十二十二十二十二十二十二十二十二十二十二	A single sub-pixel (or red, or green, or blue) of one pixel is called a point; The definition of bright spot is that in the environment of 200 ± 50 Lux, the pixels or dots seen by employees with naked eyes are always bright, and the bright spot is checked under the black screen
Scotoma	单个籍点	A single sub-pixel (or red, or green, or blue) of one pixel is called a point; A dark point is defined as a point that is not bright in a single sub-pixel seen with naked eyes in a 100% white picture under the environment of 200 ±50 Lux.
Dark spot - two connection	暗点-二连接	Two adjacent sub-pixels under the magnifying glass are not bright at the same time (horizontal, vertical and oblique)
Dark Spot - Three Links	· · · · · · · · · · · · · · · · · · ·	The adjacent R, G and B sub-pixels under the magnifying glass are not bright at the same time (horizontal, vertical and oblique)
CG monomer area		AA: Front visible area, black ink internal area; A: Black ink area; B: Cover plate edge; The front defect that runs through the AA area and



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		There are bright spots and black spots in local
		positions, including but not limited to the internal
		dirt of the screen itself, pinholes, serrations,
point defect	W. W.	concave-convex spots, color spots, tiny bubbles,
	<b>○</b> +	white spots, stains on the fitting of the polarizer,
		poor polarizer itself and other spot-like defects.
		Point defects are judged by diameter.
		Linear impurities in the screen, including filaments,
		fibers, polarizer fitting impurities in the screen, and
		scratches on the surface of polarizer, etc. Linear
100000000000000000000000000000000000000	L .	defects are judged by length and width.
Linear defect	<b>~</b> €w	Sensible scratch: also known as hard scratch, is a
	/	deep scratch on the surface, which is felt by hand.
		Senseless scratch: also known as fine scratch, no
		deep scratch on the surface, no feeling when
		touching.
Serrated defect		W: Distance from sawtooth crest to trough
		In the process of screen production, especially in
	X. Y. T.	the process of molding and cutting, the small glass
		missing at the glass edge is caused.
Edge		X direction: parallel to FOG Pad or glass edge;
collapse/angle		Y direction: perpendicular to FOG Pad or glass
collapse	Z. I	edge;
		Z direction: screen thickness direction;
		T : The thickness of single-layer glass;
		In the unit area of 10mm * 10mm, the defect point
Pitting		with D ≤ 0.1mm, DS ≥ 2mm, and the number N ≥ 5.
riding		If the customer has other requirements, follow the
		customer's requirements.





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		Including handprints, oil stains, fingerprints, stains, white fog and other undesirable phenomena. It is divided into erasable dirt and non-erasable dirt.  Use a dust-free cloth dipped in alcohol, which can not be erased as non-erasable dirt. Wipable dirt is
Dirty	-	determined as follows:  A. Dry dust-free cloth can be directly erased;
2,		B. Wipe with clean cloth dipped with anhydrous alcohol
		Press the alcohol-stained dust-free cloth on the dry
		dust-free cloth twice to absorb excess alcohol; Wipe back and forth with a dust-free cloth twice,
		and the dirt can be removed.

#### 12.2 Sampling Procedures for Each Item Acceptance Table

Critical Defect (CR): any defect that directly or indirectly affects human health and safety, or the function of the product is lost.

Major Defect (MA): directly or indirectly affect the product function, or make part of the product function lost, and other customers do not acceptable defects.

Minor Defect (MI): appearance defect that does not affect product function and can be accepted by customers.

Defect Type	Sampling Procedures	AQL
Critical Defect (CR)	Take the normal inspection solution of the sampling plan of GB/T2828.1-2012 Inspection level	0.065
Major Defect (MA)	Take the normal inspection solution of the sampling plan of GB/T2828.1-2012 Inspection level	0.65
Minor Defect (MI)	Take the normal inspection solution of the sampling plan of GB/T2828.1-2012 Inspection levelⅡ	1.0

12.3 Telecommunications Inspection Item

category	NO.	Inspection items	Inspection specification	test mode	defect type
	1	Display exception	not allow	visual	CR





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D	2	No display	not allow		CR
Poor	1000	No display	not allow	visual	CK
function	3	The picture flickers	not allow	visual	MA
TP function	4	TP test NG	not allow	visual	MA
	5	Bright dot	not allow	visual	MI
	6	Partial Bright dot	ND6% or reference limit sample	visual	МІ
Dot	7	Dark dot	1.D≤0.15mm, ignored; 2.0.15mm < D≤ 0.2mm, DS ≥ 10mm, N ≤ 10; 3.D > 0.2mm,not allowed;	Visual inspection, Flinka	MI
Line	8	Bright line	not allow	visual	MA
	9	Dark line	not allow	visual	MA
	10	Slightly bright line	not allow	visual	MA
	11	horizontal mura	No control under W64/127 screen; The 4%ND Filter on the 255 screen determines that the invisible is OK and the visible is NG.	Visual ND Filter/limit sample	MI
	12	vertical mura	No control under W64/127 screen; The 4% ND Filter on the 255 screen determines that the invisible is OK and the visible is NG.	Visual ND Filter/limit sample	MI
Mura	13	White spot	No control under W64/127 screen; The 4% ND Filter on the 255 screen determines that the invisible is OK and the visible is NG.	Visual ND Filter/limit sample	MI
	14	Black spot	No control under W64/127 screen; The 4% ND Filter on the 255 screen determines that the invisible is OK and the visible is NG.	Visual ND Filter/limit sample	MI
	15	Color mura	4% ND Filter in W64/255 screen determines that the invisible is OK and the visible is NG	Visual ND Filter/limit sample	MI



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16	snowflake	No control under W64/127 screen; The 4% ND Filter	Visual	
10	SHOWHARE	on the 255 screen determines that the invisible is OK and the visible is NG.	ND Filter/limit sample	MI
17	Twill mura	No control under W64/127 screen; The 4% ND Filter on the 255 screen determines that the invisible is OK and the visible is NG.	Visual ND Filter/limit sample	МІ
18	Newtonian ring	No control under W64/127 screen; The 4% ND Filter on the 255 screen determines that the invisible is OK and the visible is NG.	Visual ND Filter/limit sample	МІ
19	Uneven transition	Reference homogeneity standard to assist in judgment; The 4% ND Filter in the W64/255 screen determines that the invisible product is OK and the visible product is NG.	Visual ND Filter/limit sample	МІ

- Mura all specify the screen judgment. For example, if the ELA mura judgment standard is 255, the ELA mura will only be judged on the W255 screen.
- Other types of mura have a low adverse effect rate and low incidence. According to the 4% ND Filter in the W64/255 screen, the invisible products are OK and the visible ones are NG.

Dot/line of foreign material	1	Dot/line defects			
	20	(foreign material, Same point/line	Same point/line	Visual	
	20	black white dot,	specifications	inspection/Fli nka	MI
		scratch, bubble, etc.)			

12.4 Appearance Inspection Item

NO.	Inspection items	Surfac e Area	Inspection specification	test mode	defect type
1	Broken glass	AA/OA	not allow	visual	MA
2	crack	AA/OA	not allow	visual	MA
3	Edge collapse/cor ner	AA/OA	<ol> <li>Y ≤ 0.15mm, X and N are ignored;</li> <li>0.15 &lt; Y ≤ 0.4mm, X ≤ 2mm, N is ignored;</li> <li>Y &gt; 0.4mm, not allowed;</li> <li>Z ≤ t, without damage to Frit body;</li> </ol>	Visual inspection, Flinka	MI



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			X. T.		
4	flange	AA/OA	1. Y ≤ 0.2mm, X is uncontrolled; 2. Y > 0.2mm, not allowed;	Visual inspection, Flinka	MI
5	Glass warp	Whole area	The product is placed horizontally on the front and back, and the lifting height at one end (plug gauge) ≤ 0.6mm	Visual inspection, Flinka	MI
6	Pin dirty	Bongdi ng area	No control	visual	MI
7	Pin scratch	Bongdi ng area	Scratches and whitening are found by visual inspection, and need to be rechecked with a microscope. The broken lead is not allowed, and the overlap is not allowed  Note: CT pad area and pin non-bonding area are not controlled	visual	МІ
8	PF film bump	LTPS	Touch is not allowed	visual	MI
9	PF film pinholes/pit s	LTPS	No control	visual	MI
10	PF film scratch	LTPS	No scratch, no control; Scrape through, L<10mm;     The film shall be scraped through the exposed glass surface, referring to the lack of glue of PF film;	Visual inspection, Flinka	МІ
11	PF film lacks glue	LTPS	50> 5mm, W>5mm not allowed	Visual inspection, Flinka	MI
12	PF membrane is dirty	LTPS	Wipable dirt needs to be wiped, and non-wipe dirt refers to the color difference of PF film;	visual	MI
13	PF film overflow	LTPS	Edge overflow W<0.2mm, acceptable;     W>0.2mm, not allowed;	Visual inspection, Flinka	MI



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14	Color difference/st ain (no convex touch)	LTPS	No contro	ol					visual	MI
15	PF film gluing offset	LTPS	controlled	t for	0.5 ± 0.2	area, t		est shall be	Visual inspection, Flinka	MI
16	Screen body is dirty	LTPS	wiped, a cannot be	The front can be wiped and the dirt can be wiped, and the polarizer of the dirt cover cannot be wiped;     The back is not controlled;			visual	MI		
			D ( mm	)	DS ( r	nm )	Α	number	AT THE REPORT OF THE THE REPORT OF THE REPORT OF THE REPORT OF THE REPORT OF THE REPOR	
17	point defect	AA	D≤ 0.15mn	n	/			Ignore	Visual inspection,	MI
			0.15mm D≤0.2m	<	DS∋	≥10		N≤10	Flinka	
		Linear defect/forei gn matter linear/non- inductive scratch	W ( mm )	L	( mm )	DS ( mm		Acceptab le number		
	Linear		W≤ 0.03		L≤5	≥10	0	ignore		
18	defect/forei gn matter		0.03< W≤ 0.05		L≤2	≥10	0	ignore	Visual inspection,	MI
			0.03< W≤ 0.05	2	<l≤5< td=""><td>≥10</td><td>0</td><td>N≤4</td><td>Flinka</td><td></td></l≤5<>	≥10	0	N≤4	Flinka	
			W>0.0 5		-	1		Not allowed		
			-		L>5	1		Not allowed		
		Camer	D(	mm	)	Acceptable number		le number		
19	Point/Line	a hole area/Bli	D≤	€0.1	15	ignore		ore	Visual	MI
19	defects	nd hole	0.15 <	< D≤	<b>≤0.2</b>		inspection, ignore Flinka			MI
		area	D>0.2							
20	Newton rings (Blind hole area)	Camer a hole area/Bli nd hole area	Not contr	Not control				Visual inspection	MI	
21	offset	Camer a hole	The meta	al rin	g extend	s inward	0.1	mm ,ingore	Visual inspection	MI



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5		area/Bli nd hole area			
22	Blind hole color bias(same color)	Camer a hole area/Bli nd hole area	Functional requirements such as transmittance and PV value are met,not control appearance	Visual inspection	МІ
23	Protective film scratch	Whole area	No control under no hurt boby	Visual inspection	MI
24	Protective film starved/ove rflow glue/burr	Whole area	No control under no hurt boby	Visual inspection	МІ
25	Dirt inside the protective film	Whole area	Not allowed	Visual inspection	MI
26	Easy to tear	Cover front	Function is invalid, damaged, leaked not allowed Wrinkles, bumps, dirt, punching bad, burr, overflow glue is not controlled	Visual inspection	МІ
27	Polarizer edge overflow	AA	W≤0.35mm , Not control: W>0.35mm, Not allowed.	Visual inspection, Flinka	MI
28	Polarizer concave convex point	AA	convex point: D ≤ 0.2mm or refer to limit sample concave point: D≤3mm, DS≥10mm, N≤3 or refer to limit sample	Visual inspection, Flinka	МІ
29	Polarizer fold / indentation	AA	Does not affect the display as OK or refer to limit sample;	Visual inspection	MI
30	Polarizer chromatism	AA	No control	Visual inspection	MI
31	IC chip	IC	Not allowed	Visual inspection	MI
32	FPC body defect	FPC	1. The parts on the FPC must be consistent with the product BOM table, and there are incorrect, multiple, or missing parts, which are not allowed; Polarities such as capacitors and inductors should not be soldered backwards or crooked;  2. FPC scratches/scratches are based on the absence of exposed copper;  3. Creases/Indentations: Indentations in the	Visual inspection	МІ

circuit area should not cause the back of the



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33	FPC gold finger defect	Golden Finger Region	covering film to turn white; Non line area indentation should not cause FPC damage  4. Except for the golden finger. FPC foreign object: a. Spot shape: D ≤ 0.5mm, N ≤ 3; b. Linear: length and width ≤ 0.3 * 5mm;  1. Golden finger cracking: The length and width of the crack/damage at the top of the golden finger ≤ the line width;  2. Gold finger copper leakage: W ≤ 1/3 line width, L ≤ line width, unlimited quantity  3. Gold finger gap W1 ≤ 1/3 line width W, length L1 ≤ 1/2 line width W, unlimited quantity, all of the above conditions are met and allowed;  4. Gold finger pressure/scratch should not expose copper, there should be no unevenness, and there should be no depth visible to the naked eye, which does not affect assembly and is acceptable;  5. Gold fingers should not have sharp creases or dead folds;  6. FPC gold fingers should not have oxidation,	Visual inspection	MI
34	connector	connect	blackening, burns, or browning;  There should be no tin or residual solder beads on the connector, and there should be no tin connection on the connector pins; PIN deformation shall be controlled within 0.05mm; Does not affect the lighting function; Visual inspection of pin breakage, pin detachment, and deformation of the outer frame is not allowed;	Visual inspection	МІ
		Bondin g area	There must be no obvious wrinkles or bubbles		
35	Insulating tape	Compo nent area	Scratches and glue splashes are uncontrollable;     Do not wipe dirt or dirt;     The offset of the insulation tape should not exceed the edge of the product, and other requirements should be determined based on	Visual inspection	MI

4. Burr edges, no control over glue overflow;

the drawing;



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			5. Damaged, incomplete, or missing labels are	0	20
36	Composite tape	All	not allowed;  1. It is not allowed for the composite tape to leak out of the edge of the screen body;  2. Folding of composite tape, light leakage during assembly, or affecting assembly and thickness are not allowed;  3. Damaged composite tape is not allowed;  4. The size of the composite tape cutting defect does not meet the requirements of the drawing and cannot be controlled;  5. Composite tape should not be wiped with dirt or foreign objects, and foreign objects should follow the dotted line standard;  6. The burrs of the composite tape should not exceed the edge of the screen body, regardless of control;  8. Composite adhesive tape with no control over glue splashes or overflow;  9. Composite tape bubbles: D ≤ 5mm, N not included;  10. Composite tape bumps: acute angle bumps D ≤ 0.3mm, N ≤ 3; Smooth concave convex points D ≤ 0.8mm, N ≤ 3;  11. Composite tape foreign object (foreign object between copper foil and blue film): D ≤ 0.3mm, N ≤ 3;  12. Edge sawtooth of composite tape: 0.5 * 3mm, N ≤ 3;  13. The color difference of the protective film in the composite tape is not controlled;  14. Copper foil indentation and dead bending in composite tape are not allowed, which does not affect assembly and thickness control; Or reference limit sample;  15. No control of foreign objects/dents in copper foil in composite tape;	Visual inspection	MI
37	OCA overflow	All	Not allowed within AA area; Externally visible: Control standard ≤ 0.15mm	Visual inspection	MI





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			<b>ISPLA</b>	<u>Y SELL</u>

38	Sealing glue	Pin	<ol> <li>Broken adhesive is not allowed, and the circuit cannot be exposed.</li> <li>The thickness of the colloid shall not be higher than the POL surface.</li> <li>Bubble diameter&lt;1mm.</li> <li>Other: According to the drawings and work instructions.</li> </ol>	Visual inspection	МІ
39	Conductive cloth	All	<ol> <li>Conductive cloth dirt: D ≤ 5mm, N ≤ 2;</li> <li>Conductive cloth bubbles: D ≤ 2mm, N ≤ 2;</li> <li>Conductive cloth foreign object: D ≤ 1mm, N ≤ 3;</li> <li>Folding of conductive fabric: N ≤ 2;</li> </ol>	Visual inspection	МІ
40	Copper foil	All	Copper foil sticking is not allowed to leak out of the edge of the screen body; Abnormal color of copper foil refers to standard samples/sealed samples, and damage is not allowed. Soft scratches on the surface are not controlled.	Visual inspection	МІ
41	QR code	QR code	It is not allowed to be unable to scan or difficult to scan (recognition can only be achieved after three consecutive scans), with a clear appearance, no blurring, missing printing, and other defects	Visual inspection	МІ
42	Package	Other	Products should put into the anti-static trays, with non-overlapping, and the trays should be staggered placed.  Different products cannot be mixed into the same inner package.  The package should not have obvious deformation or breakage .The printing labels type and quantity are correct.  The package should have QC signature. ROHS label is needed if the product is under ROHS control.	visual	
43	Boundary dimension NG	Other	It is not allowed to exceed the dimensional tolerance required by the specifications and drawings	Calipers, measuring instruments	1

12.5 Inspection picture library

Serial picture Picture name Ma	nly judged as defective remarks
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-	0			
1		W_ GRAD(64) 64 gray scale	Point/line type, foreign matter point/line, mura type	1
2		W_ GRAD(128) 128 gray scale	Point/line type, foreign matter point/line, mura type	1
3		WHITE white	Point/line type, foreign matter point/line, mura type	1
4		Black black	Bright spot, bright line, dark mura	1
5		RED red	Point type, line type, foreign matter point/line	1
6		GREEN green	Point type, line type, foreign matter point/line	1
7		BLUE blue	Point type, line type, foreign matter point/line	1

Note: The actual sequence and lock seconds of the screen can be adjusted according to the customer's requirements and the needs of the factory.



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### 13. PRECAUTIONS FOR USE OF AMOLED MODULES

- 13.1 Handling Precautions:
- 13.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from height.
- 13.1.2 Do not press down the screen or the adjoining areas too hard because the color tone may be shifted.
- 13.1.3 The polarizer covering the display surface of the AMOLED module is soft and easily scratched. Handle this polarizer carefully.
- 13.1.4 If the display surface is contaminated, blow on the surface and gently wipe it with a soft dry cloth. If it is still not completely clear, moisten the cloth with ethyl alcohol.
- 13.1.5 Solvents may damage the polarizer. Do not use water, ketone or aromatic solvents except ethyl alcohol.
  Do not attempt to disassemble the AMOLED Module.
- 13.1.6 If the logic circuit power is off, do not apply the input signals.
- 13.1.7 To prevent destruction from static electricity, be careful to maintain an optimum working environment.
- 13.1.8 Be sure to make yourself in contact with the ground when handling with the AMOLED Modules.
- 13.1.9 Tools required for assembly, such as soldering irons, must be properly ground.
- 13.1.10 To reduce the generation of static electricity, do not conduct assembly or other work under dry conditions.
- 13.1.11 To protect the display surface, the AMOLED Module is coated with a film. Be careful when peeling off this protective film, because static electricity may generate.
- 13.2 Storage Precautions:
- 13.2.1 When storing the AMOLED modules, be sure that they are not directly exposed to the sunlight or the light of fluorescent lamps.
- 13.2.2 The AMOLED modules should be stored under the storage temperature range. If the AMOLED modules will be stored for a long time, the recommended condition is: Temperature: 0°C~40°C Relatively humidity: ≤80%
- 13.2.3 The AMOLED modules should be stored in the room without acid, alkali or harmful gas.
- 13.3 Transportation Precautions:
- 13.3.1 The AMOLED modules should not be suffered from falling and violent shocking during transportation. Besides, excessive press, water, damp and sunshine, should be avoided.